# **AF Control LSI**

# LC898249XH

#### Overview

This LSI is Closed–Auto Focus control LSI equipped with hall sensor. It consists of 1 system of feedback circuit and constant current driver. It has also a built–in EEPROM and temperature sensor.

#### Features

- Built-in Equalizer Circuit Using Digital Operation
  - AF Control Equalizer Circuit
  - Any Coefficient can be Specified by 2-wire Serial I/F (TWIF)
- 2-wire Serial Interface
  - (The Communication Protocol is Compatible with I<sup>2</sup>C)
  - 4 Selectable Slave Addresses
    - -50h(W)/51h(R), 53h(R)
    - -74h(W)/75h(R), 77h(R)
    - E8h(W)/E9h(R), EBh(R)
    - E4h(W)/E5h(R), E7h(R) factory-configured
    - Right Side Addresses are Used at the Access of Built-in EEPROM
- Built-in A/D Converter
- Built-in D/A Converter
  - Hall Offset
  - Constant Current Bias
- Built-in Hall Sensor
  - Si Hall Sensor
- Built-in EEPROM
  - ◆ 64 Byte (16 Byte / Page)
- Built-in OSC
- Built-in Constant Current Driver
  - ♦ 150 mA
- Package
  - WLCSP 6-pin (2 x 3 Pin), Thickness Max 0.29 mm, with Backside Coat
- Supply Voltage
  - VDD (2.6 V to 3.3 V)
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant



# **ON Semiconductor®**

www.onsemi.com



WLCSP6, 0.86x1.75x0.265 CASE 567XD

#### MARKING DIAGRAM

|  | 0 | 8249XH<br>ALYWW |  |
|--|---|-----------------|--|
|--|---|-----------------|--|

8249XH = Specific Device Code

- = Assembly Location
- = Wafer Lot
- = Year

А

L

Υ

WW = Work Week

#### **ORDERING INFORMATION**

| Device        | Package | Shipping <sup>†</sup> |
|---------------|---------|-----------------------|
| LC898249XHTBG | WLCSP6  | 4000 / Tape<br>& Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **PIN DESCRIPTION**

#### Table 1. PIN DESCRIPTION

| Pin Name | Description       |
|----------|-------------------|
| 1        | Input             |
| Р        | Power Supply, GND |
| NC       | Not Connect       |
| 0        | Output            |
| В        | Bidirection       |

• 2-wire serial interface

| SCL | Ι | 2-wire serial interface clock pin |
|-----|---|-----------------------------------|
| SDA | В | 2-wire serial interface data pin  |

- Driver interface OUT1 O Driver output (to Actuator)
- OUT2 O Driver output (to Actuator)

| • | Power | suppl | y pin     |     |
|---|-------|-------|-----------|-----|
|   | VDD   | Р     | Power Sup | ply |
|   |       |       |           |     |

VSS P GND

#### \*Process when pins are not used

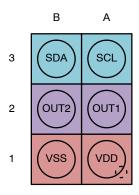
PIN TYPE "O" – Ensure that it is set to OPEN. PIN TYPE "I" – OPEN is inhibited. Ensure that it is connected to the VDD or VSS even when it is unused. (Please contact ON Semiconductor for more information about selection of VDD or VSS.) PIN TYPE "B" – If you are unsure about processing method on the pin description of pin layout table, please contact us.

Note that incorrect processing of unused pins may result in defects.

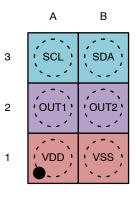
### **PIN LAYOUT**

#### Table 2. PIN LAYOUT

| Circuit Name | Number of PINs |
|--------------|----------------|
| Driver       | 2              |
| Power        | 2              |
| Logic        | 2              |



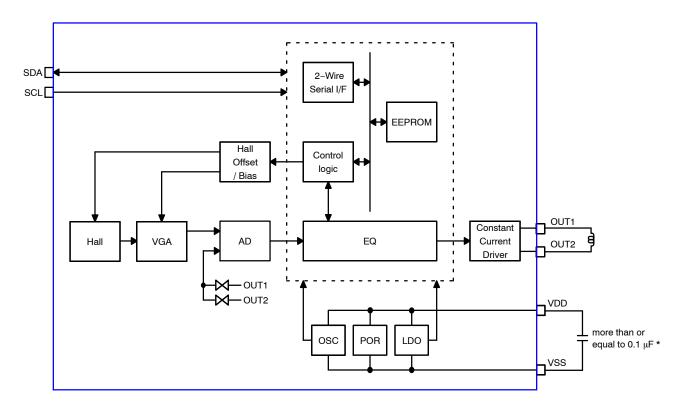
BOTTOM VIEW



TOP VIEW



#### **BLOCK DIAGRAM**



\*Consider capacitance of capacitor between VDD and VSS. According to power source environment, attach an additional capacitor in camera module.

#### Figure 2. Block Diagram

#### HALL ELEMENT POSITION

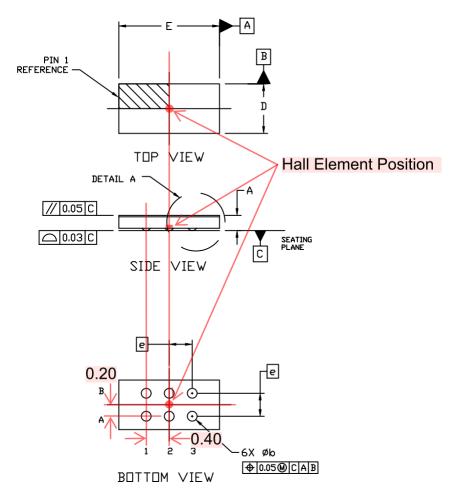


Figure 3. Hall Element Position

#### **ELECTRICAL CHARACTERISTICS**

#### Table 3. ABSOLUTE MAXIMUM RATINGS (VSS = 0 V)

| Symbol                              | Item                          | Condition | Rating                        | Unit |
|-------------------------------------|-------------------------------|-----------|-------------------------------|------|
| V <sub>DD</sub> 33 max              | Supply voltage                | Ta ≤ 25°C | -0.3~4.6                      | V    |
| V <sub>I</sub> 33,V <sub>O</sub> 33 | Input/output voltage          | Ta≤25°C   | -0.3~V <sub>DD</sub> 33 + 0.3 | V    |
| Tstg                                | Storage ambient temperature   |           | -55~125                       | °C   |
| Topr                                | Operating ambient temperature |           | -30~70                        | °C   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### Table 4. ACCEPTABLE OPERATION RANGE (Ta = -30~70°C, VSS = 0 V, 3 V power supply (VDD))

| Symbol             | Item                | Min | Тур | Max                | Unit |
|--------------------|---------------------|-----|-----|--------------------|------|
| V <sub>DD</sub> 33 | Supply voltage      | 2.6 | 2.8 | 3.3                | V    |
| V <sub>IN</sub>    | Input voltage range | 0   | _   | V <sub>DD</sub> 33 | V    |

#### Table 5. DC CHARACTERISTICS (Input / output level at VSS = 0 V, VDD = 2.6 V~3.3V, Ta = -30~70°C)

| Symbol | ltem                     | Condition              | Min | Тур | Max | Unit | Applicable Pins |
|--------|--------------------------|------------------------|-----|-----|-----|------|-----------------|
| VIH    | High-level input voltage | CMOS compliant schmitt | 1.4 | -   | -   | V    | SCL, SDA        |
| VIL    | Low-level input voltage  |                        | -   | -   | 0.4 | V    |                 |
| VOL    | Low-level output voltage | IOL = 2 mA             | -   | -   | 0.2 | V    | SDA             |

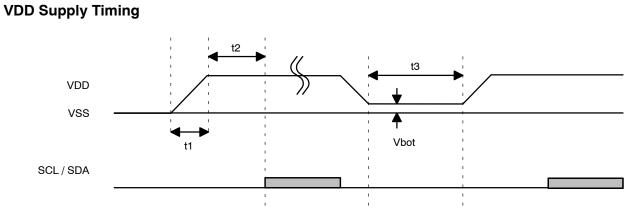
#### Table 6. DRIVER OUTPUT (OUT1, OUT2) (VSS = 0 V, VDD = 2.8 V, Ta = 25°C)

| Symbol | ltem            | Condition | Min   | Тур | Мах   | Unit | Applicable Pins |
|--------|-----------------|-----------|-------|-----|-------|------|-----------------|
| Ifull  | Maximum current |           | 142.5 | 150 | 157.5 | mA   | OUT1, OUT2      |

#### Table 7. NON-VOLATILE MEMORY CHARACTERISTICS

| Symbol | Item           | Condition | Min | Тур | Max  | Unit   | Applicable Circuit |
|--------|----------------|-----------|-----|-----|------|--------|--------------------|
| EN     | Endurance      |           | -   | -   | 1000 | Cycles | EEPROM             |
| RT     | Data retention |           | 10  | -   | -    | Years  |                    |
| tWT    | Write time     |           | _   | -   | 20   | ms     |                    |

#### AC CHARACTERISTICS



#### Figure 4. VDD Supply Timing

It is available to use 2-wire serial interface 5ms later for Power On Reset of VDD.

#### Table 8. VDD SUPPLY TIMING

| Symbol | Item   | Min | Тур | Max | Unit |
|--------|--|-----|-----|-----|------|
| t1     | VDD turn on time                               | -   | -   | 3   | ms   |
| t2     | 2-wire serial interface start time from VDD on | 5   | -   | -   | ms   |
| t3     | VDD off time                                   | 100 | -   | -   | ms   |
| Vbot   | Bottom Voltage                                 | -   | -   | 0.1 | V    |

#### **AC Specification**

Figure 5 shows interface timing definition and Table 9 shows electric characteristics.

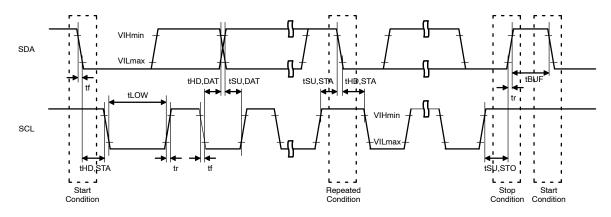


Figure 5. 2–wire Serial Interface Timing Definition

| Symbol  | Item                                      | Pin<br>Name | Fast-mode     |     |     | Fast-mode Plus |     |      |      |
|---------|---|-------------|---------------|-----|-----|----------------|-----|------|------|
|         |   |             | Min           | Тур | Max | Min            | Тур | Max  | Unit |
| FSCL    | SCL clock frequency                       | SCL         | -             | -   | 400 | -              | -   | 1000 | kHz  |
| tHD,STA | START condition hold time                 | SCL<br>SDA  | 0.6           | -   | _   | 0.26           | -   | -    | μs   |
| tLOW    | SCL clock Low period                      | SCL         | 1.3           | -   | -   | 0.5            | -   | -    | μs   |
| tHIGH   | SCL clock High period                     | SCL         | 0.6           | -   | -   | 0.26           | -   | -    | μs   |
| tSU,STA | Setup time for repetition START condition | SCL<br>SDA  | 0.6           | -   | _   | 0.26           | -   | -    | μs   |
| tHD,DAT | Data hold time                            | SCL<br>SDA  | 0<br>(Note 1) | -   | 0.9 | 0<br>(Note 1)  | -   | -    | μs   |
| tSU,DAT | Data setup time                           | SCL<br>SDA  | 100           | -   | _   | 50             | -   | -    | ns   |
| tr      | SDA, SCL rising time                      | SCL<br>SDA  | -             | -   | 300 | -              | -   | 120  | ns   |
| tf      | SDA, SCL falling time                     | SCL<br>SDA  | -             | -   | 300 | -              | -   | 120  | ns   |
| tSU,STO | STOP condition setup time                 | SCL<br>SDA  | 0.6           | -   | _   | 0.26           | -   | -    | μs   |
| tBUF    | Bus free time between STOP and START      | SCL<br>SDA  | 1.3           | _   | _   | 0.5            | _   | _    | μs   |

#### Table 9. ELECTRICAL CHARACTERISTICS FOR 2-WIRE SERIAL INTERFACE (AC CHARACTERISTICS)

1. This LSI is designed for a condition with typ. 20 ns of hold time. If SDA signal is unstable around falling point of SCL signal, please implement an appropriate treatment on board, such as inserting a resistor.

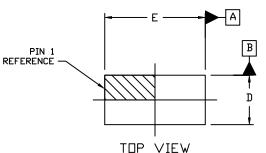
ON Semiconductor is licensed by the Philips Corporation to carry the  ${\rm I}^2{\rm C}$  bus protocol.



WLCSP6, 0.86x1.75x0.265 CASE 567XD

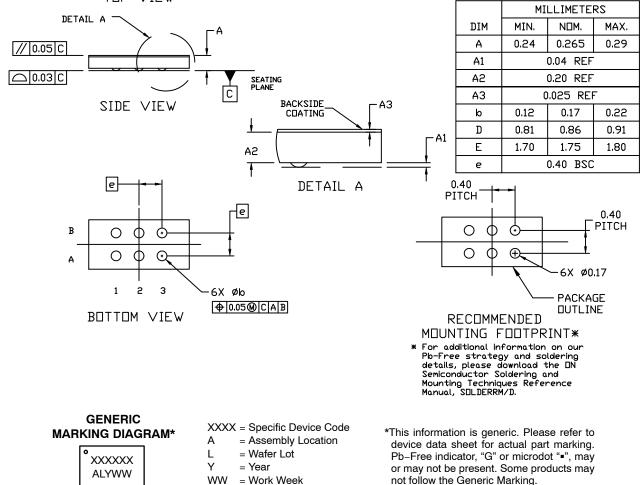
ISSUE O

DATE 23 OCT 2018



#### NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPERICAL CROWNS OF THE CONTACT BALLS.
- 4. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE CONTACT BALLS.
- 5. DIMENSION 6 IS MEASURED AT THE MAXIMUM CONTACT BALL DIAMETER PARALLEL TO DATUM C.



| DOCUMENT NUMBER:   | 98AON99381G             | Electronic versions are uncontrolled except when accessed directly from the Document Repository.<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |  |  |  |  |  |  |
|--|-------------------------|---|--|--|--|--|--|--|
| DESCRIPTION:   | WLCSP6, 0.86x1.75x0.265 | PAGE 1 OF 1   |  |  |  |  |  |  |
| ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries.<br>ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights or the rights of others. |                         |   |  |  |  |  |  |  |

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

#### TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

 $\Diamond$